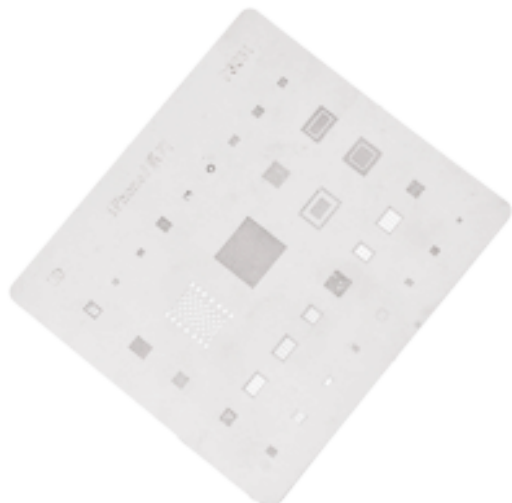


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BGA stencil for iPhone 6 (P3031)

Product ID: 17120

Price: **7.00 EUR**

Product weight: **0.10 kg**

Description:

BGA stencil for iPhone 6 (P3031) is chip ball template for BGA IC after reballing.

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